

Getting to know a hybrid pixel detector

Functional tests, equalization and energy calibration of Timepix1 pixel detector assembly

Chiara Marina Jerkovic

Supervised by Justus Braach & Peter Svihra

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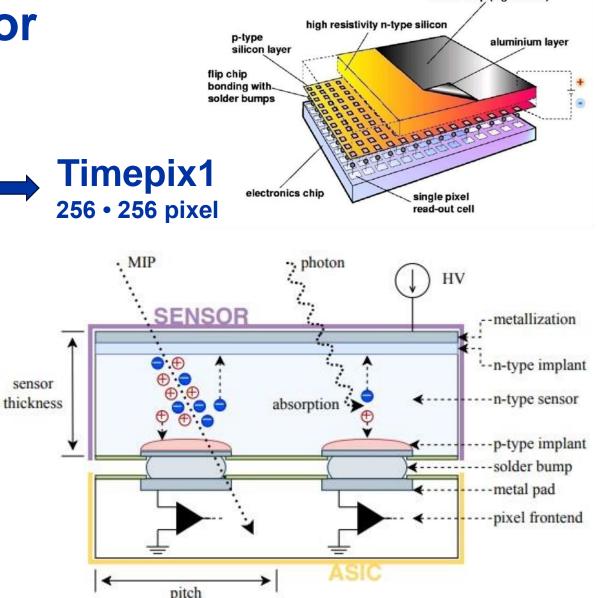
Hybrid Silicon Pixel Detector

Structure

- Sensor (pixel array, matrix of silicon diodes) + read out chip
- Sensor and ASIC connected with solder bumps
- Charge is collected by sensor and is read out by an individual ASIC channel
- Further signal processing in read-out ASIC

Reversed bias operation

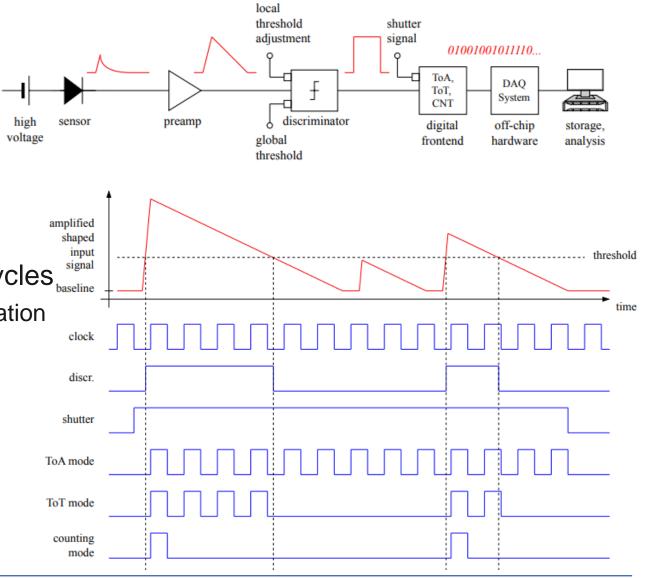
- Interaction of Si atoms and charged particle produce electron-hole-pairs
- Holes collected by anode, electrons move to cathode
- Moving charge induces measurable signal





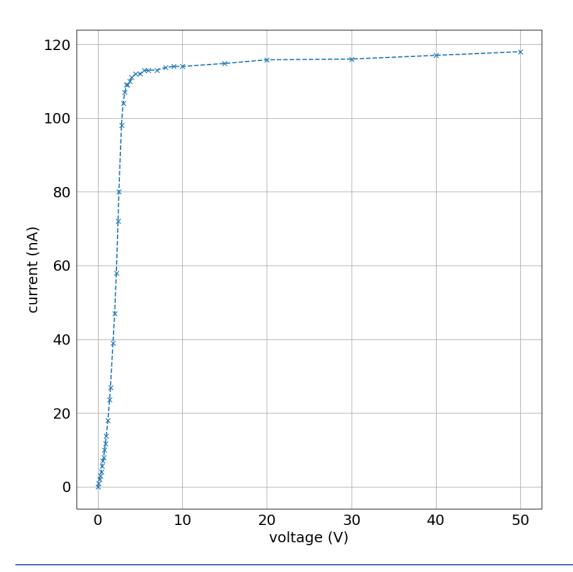
Signal Processing

- Sensor output small & complex in shape
 → Amplification & signal shaping (triangular)
- Discriminator compares signal to threshold
 - \rightarrow Filter unwanted information (e.g. noise)
 - \rightarrow Reduces complexity of signal information
- Information represented by counting clock cycles signal baseline
 - → Triangular signal shape retains amplitude information by measuring time over threshold
- Observables:
 - Time of arrival (ToA)
 - Time over threshold (ToT)
 - Ooccurrence (count)





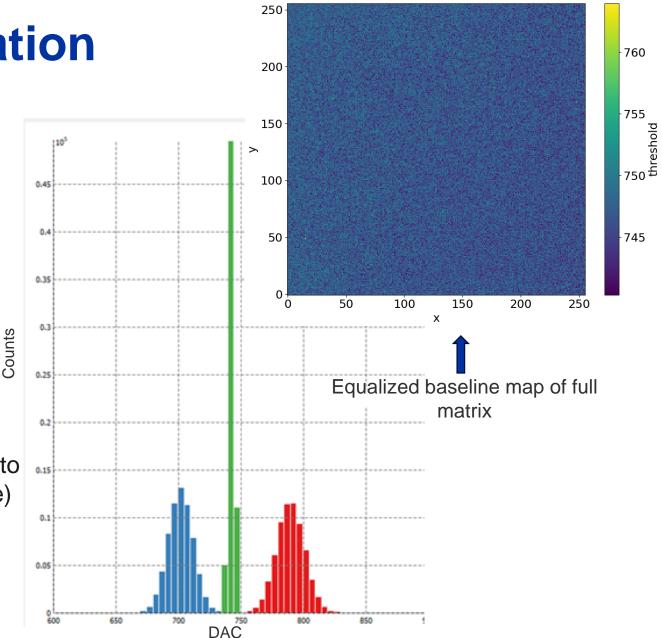
Current-Over-Voltage Measurement



- First test of basic principles of sensor
- Verification of voltage range for reverse biased operation at stable current
- Positive voltage is applied
 - \rightarrow Small, largely constant current
 - → Reversed direction, depletion region grows with increasing voltage until it spans the thickness of sensor
- Reverse bias operation by applying positive voltages
- Signal by hole collection

Pixel Response Equalization

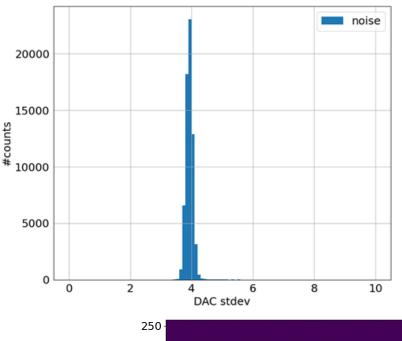
- Read-out channels show differences in response to a given signal
 - → Different baselines, caused by little differences in production
- Local per-pixel adjustment enables to equalize differences in response
 - → Adjust every pixel to maximum of local adjustment (blue distribution)
 - → Adjust every pixel to minimum of local adjustment (red distribution)
 - → Calculate the per pixel adjustment necessary to shift all pixels to center (between red and blue)
- Equalization result (green): most probable baseline at 749DAC

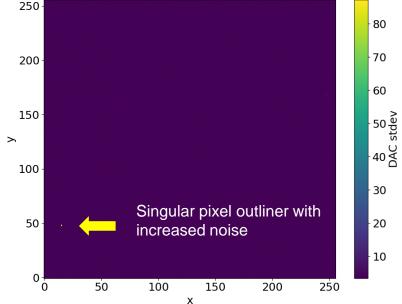




Pixel Noise

- Every pixel has noise → adjust threshold to only see physics signals
- Scanning global threshold across most probable baseline
 - $\rightarrow\,$ Turn-on s-shaped curve as threshold is lowered into noise
- Standard deviation of turn-on curve is a measure for the noise
- $\sigma = 3.9$ most probable noise for all pixels
- 5 sigma from threshold away
 → Close to 100% chance of not seeing noise
- Calculated operational threshold: 749DAC 5 3.9DAC = 729DAC
- Manual threshold adjustment to 720DAC because of non-gaussian behavior in tails of distribution

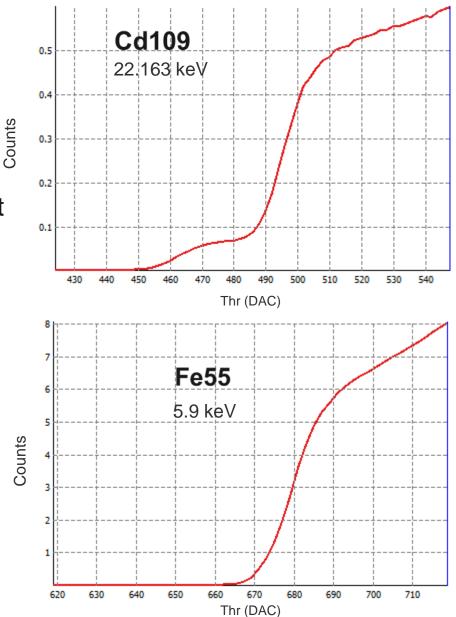






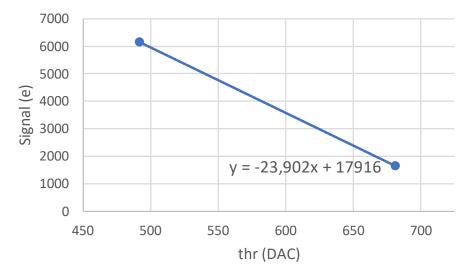
Threshold Calibration

- Photons from gamma sources of known energy
 - → Nuclei decay to a lower energy state by emitting a gamma ray photon of characteristic energy
- Assuming constant rate from source during measurement
 - \rightarrow Constant count per frame with shutter length 1ms
- Threshold scan with source
 - \rightarrow Record number of hits in frame per threshold
 - $\rightarrow\,$ Steepest slope when thr_DAC crosses photon energy of the source
 - \rightarrow S-like curve
- Deformation of s-shape at turn-on and linear slope for threshold below signal amplitude
 - \rightarrow Fluctuations of baseline
 - $\rightarrow\,$ Charge sharing between pixels reduces single-pixel signal $\rightarrow\,$ detection occurs at lower threshold

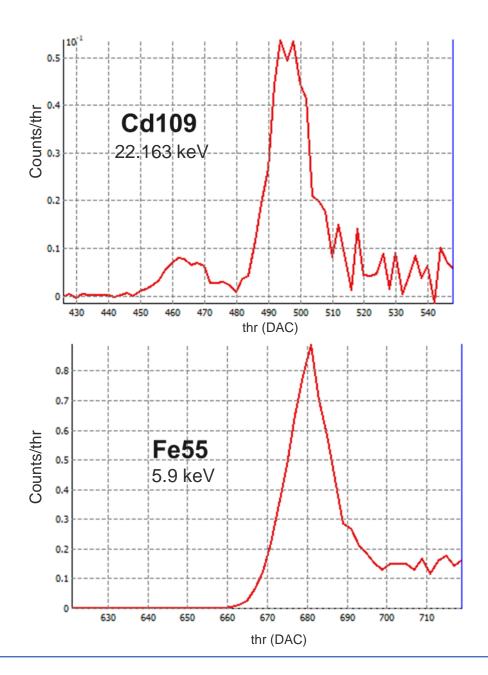


Threshold Calibration

- Analysis of s-curve
 - \rightarrow Find maximum of derivative
 - \rightarrow Extract corresponding thr_DAC value
- Plotting signal in electrons (3.6eV per e-h-pair) over thr_DAC



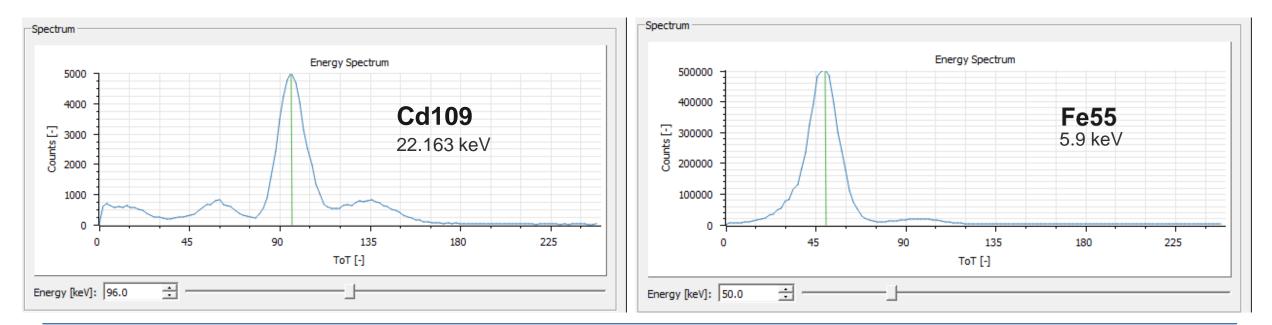
► Operational threshold = 720 DAC → 706 electrons



thr-Calibration

ToT Energy Calibration

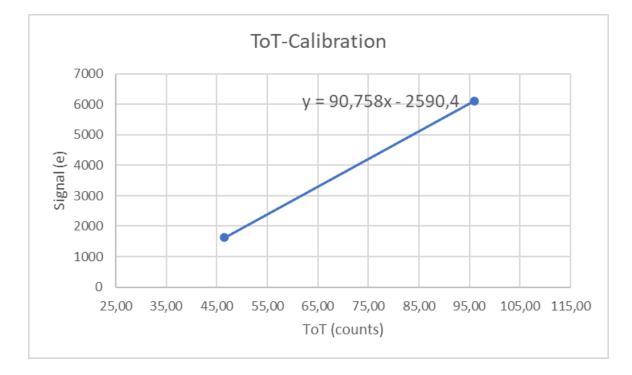
- Photons from gamma sources of known energy
- Dominant peaks form in ToT spectrum for both sources
 - \rightarrow Peak relates to energy of source emission line
 - → Convert energy to equivalent signal (3.6eV per e-h-pair)





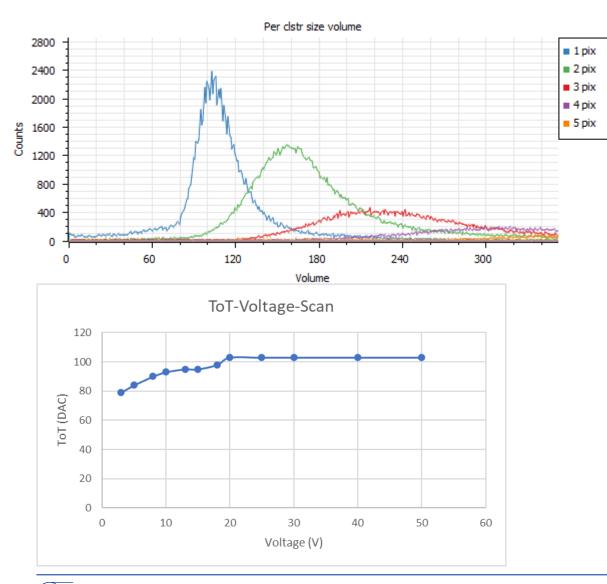
ToT Energy Calibration

- Plotting signal against MVP ToT (peak position) yields linear relation
- Fit parameters slope & offset allow a conversion of measured ToT (DAC) to Signal (e)





Depletion Voltage and Thickness of Sensor



- Measure with Sr90 (minimum ionizing particles)
 - \rightarrow Signal through ionization along path through sensor
 - \rightarrow 76 e-h-pairs per μm in silicon
- Apply clustering to select particle tracks that cause single pixel deposition
 - → Selecting straight tracks, mostly perpendicular to sensor surface
- Plotting most probable ToT against voltage
 - \rightarrow Drop signal below 20V; depletion depth smaller than physical thickness
 - → Full depletion above 20V; constant ToT value; depletion reached physical thickness of sensor
- Calculate sensor thickness
 - \rightarrow From ToT calibration: 103 DAC = 6750e
 - \rightarrow 6750e/76e per µm = 88.8µm



Conclusion

- Objective: Functional tests, equalization and energy calibration of a Timepix1 pixel detector assembly
- Verification of voltage range for reverse biased operation at stable current
- Equalization of pixel baselines to most probable value of 749DAC
- Average pixel noise of 4DAC steps \rightarrow noise free operational threshold below 729DAC
- Operational threshold was manually adjusted to 720DAC steps
- Threshold energy calibration using radioactive photon sources yields an operational threshold of 706 electrons
- Time over threshold calibration: signal = -24 ToT + 17900
- From single-pixel ToT-over-voltage scan \rightarrow full depletion found for bias voltages above 20V
- Calibration confirmed by extracting width of depleted volume at full depletion \rightarrow 88.8µm





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Thank you for your attention Getting to know a hybrid pixel detector

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Basic principles Silicon-Diode

Silicon is an element of 5th group

P-type

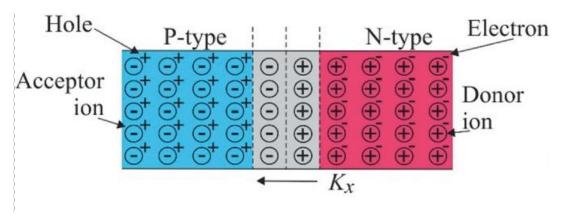
- Doping with element of 3rd group
- Dopants are prone to accept an electron

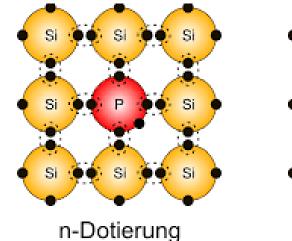
N-type

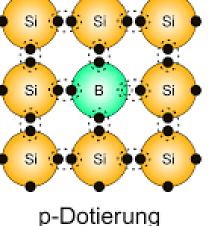
- doping with element of 5th group
- Dopants are prone to donate an electron

Depleted region

- Holes and electrons recombine at the interface
- Applying external potential changes amount of available fee charge carriers in diode
 - \rightarrow modifies the depleted region
- Depletion can be decreased -> current is able to flow
 → forward biased
- Depletion can be increased -> current is hindered to flow
 → reversed operation
- Forward/reversed operation

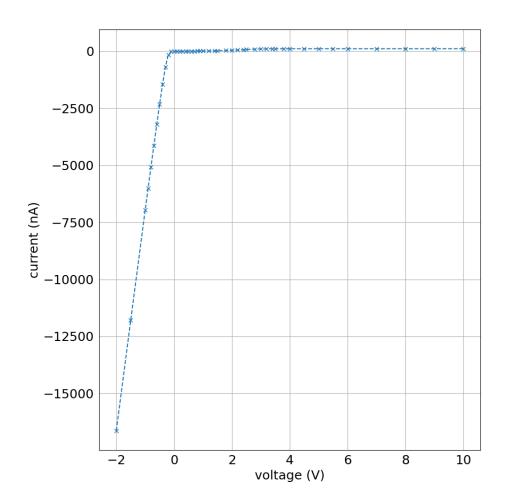








Current-Over-Voltage Measurement



- First test of basic principles of sensor
- Verification of voltage range for reverse biased operation at stable current
- Negative voltage is applied
 - → Current increasing with increasing negative voltage
 - \rightarrow forward direction, no depleted region
- Positive voltage is applied
 - \rightarrow small, largely constant current
 - → reversed direction, depletion region grows with increasing voltage until it spans the thickness of sensor
- Sensor contains p-in-n pixel diodes
- Reverse bias operation by applying positive voltages
- Signal by hole collection